## **Declaration for U.S. Patent Application**

As	a	below	named	inventor,	Ι	hereby	dec.	lare	that:
----	---	-------	-------	-----------	---	--------	------	------	-------

My r	esidence,	post	office address	and	citizenship	are as	stated	below	next to	my name.
------	-----------	------	----------------	-----	-------------	--------	--------	-------	---------	----------

names are liste	d below) of the subject	et matter which is claimed and for	s listed below) or an original, first and join or which a patent is sought on the invention NOUT DIAGNOSING FUNCTION	· -
the specification	on of which is attached	hereto unless the following is cl	hecked	
-		_		
	was filed on	as United States App	plication Number or PCT International A	pplication Number
ليا		and was amended on	(if applicable).	

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claim(s), as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, § 1.56.

I hereby claim foreign priority benefits under Title 35, United States Code, § 119 (a) - (d) of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application for which priority is claimed:

(List prior	2000-169960	Japan	07/06/2000	Priority Claimed XX Yes No
foreign	(Number)	(Country)	(Day/Month/Year Filed)	_ 10310
applications.	(Nulliber)	(Country)	(Day/Month Feat Filed)	Yes No
See note A on	(Number)	(Country)	(Day/Month/Year Filed)	
back of this page)				Yes No
page)	(Number)	(Country)	(Day/Month/Year Filed)	
				Yes No
	(Number)	(Country)	(Day/Month/Year Filed)	

(See note B on back of this page)

See attached list for additional prior foreign applications

I hereby claim the benefit under Title 35, United States Code, § 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, § 112, I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, § 1.56 which became available between the filing date of the prior application and the national or PCT international filing date of this application.

(List Prior U.S. Applications)	(Appln. Serial No.)	(Filing Date)	(Status: Patented, Pending, Abandoned)		
	(Appln. Serial No.)	(Filing Date)	(Status: Patented, Pending, Abandoned)		
	(Appln. Serial No.)	(Filing Date)	(Status: Patented, Pending, Abandoned)		

I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:



PATENT TRADEMARK OFFICE

Please direct all communications to the following address:



PATENT TRADEMARK OFFICE

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Title 18 of the United States Code, § 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

(See note C	Full name of sole or first inventor (given name, family name) _	Yoshiaki AKAMATSU
above)	Inventor's signature Joshiaki Akamatsu	
institution of the second of t	Inventor's signature / OM, aki / The wat 311	Date Opri B. John
	Residence Yamatokoriyama-shi, Nara, Japan	CitizenshipJapan
	Post Office Address <u>c/o MORI SEIKI CO., LTD.</u>	
1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1	106, Kitakoriyama-cho, Yamatokoriy	ama-shi, Nara, 639-1160, Japan
is distant Exemp		
e comment	inventor (given name, family name)Makoto FUJISHIMA	
Inventor's signature	Makoto Finjishime Date	APR. 10. 2001
G adopti E	,	
Residence	Yamatokoriyama-shi, Nara, Japan	Citizenship <u>Japan</u>
Post Office Address	c/o MORI SEIKI CO., LTD.	
	106, Kitakoriyama-cho, Yamatokoriyama-shi, Nara, 639-116	0, Japan
Full name of third in	ventor (given name, family name)	
Inventor's signature	Da	ıte
Residence		Citizenship
Post Office Address		

## **NOTES**

- A. Please list all foreign applications relating to the invention and check block "yes" or "no".
- B. If more than 4 prior foreign applications, please check this box and attach a sheet listing the remaining prior foreign applications.
- C. For residence in the U.S., indicate <u>city and state</u>, for residence outside the U.S., indicate <u>city and country</u>. The "Post Office Address" must be an address acceptable by a Post Office for delivery of mail.